

Docket No. 217494US8

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JC564 U.S. PTO
10/015627

12/17/01

IN RE APPLICATION OF: Sadayoshi KANEMARU, et al.

SERIAL NO. NEW APPLICATION

FILING DATE: HEREWITH

FOR: SEMICONDUCTOR LASER ELEMENT, SEMICONDUCTOR LASER MODULE, FABRICATION
METHOD THEREOF AND AMPLIFIER FOR OPTICAL FIBER

STATEMENT RE FILING IN FOREIGN LANGUAGE

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

It is hereby stated that the subject application is being filed in a foreign language, in accordance with the provisions of 37 CFR 1.52(d).

An accurate English translation, and a suitable amendment placing the application and claims thereof into proper U.S. format if needed, will be filed in due course.

Respectfully Submitted,

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